

CLAIMS

What is claimed is:

1. An apparatus, comprising:

one or more heat exchanger components that in major part are operably locatable
5 outside a computer chassis and serve to reduce one or more temperatures of one or more heat
producing components supported within the computer chassis.

2. The apparatus of claim 1, wherein the one or more heat exchanger components
comprise a heat exchanger component, wherein the heat exchanger component comprises one
or more portions of tubing;

10 wherein the heat exchanger component passes a fluid through the one or more
portions of tubing to reduce one or more of the one or more temperatures of the one or more
heat producing components.

3. The apparatus of claim 2, wherein the heat exchanger component comprises
one or more fins, wherein the fluid transfers heat to the one or more fins as the fluid passes
15 through one or more of the one or more portions of tubing against the one or more fins;

wherein the one or more fins promote a reduction in the one or more of the one or
more temperatures of the one or more heat producing components.

4. The apparatus of claim 3, wherein the one or more portions of tubing comprise one or more heat transfer sections, wherein the one or more heat transfer sections comprise a first heat transfer section that abuts the one or more heat producing components;

wherein the heat exchanger component moves the fluid through the first heat transfer
5 section to promote a transfer of heat from the one or more heat producing components, wherein the transfer of heat from the one or more heat producing components serves to reduce the one or more of the one or more temperatures of the one or more heat producing components;

wherein the one or more heat transfer sections comprise a second heat transfer section
10 that abuts the one or more fins, wherein the heat exchanger component moves the fluid against one or more of the one or more fins to transfer heat from the fluid to the one or more of the one or more fins.

5. The apparatus of claim 3, wherein the heat exchanger component dissipates heat through the one or more fins to reduce the one or more of the one or more temperatures
15 of the one or more heat producing components.

6. The apparatus of claim 5, wherein the heat exchanger component employs a natural convection outside of the computer chassis to dissipate the heat, wherein one or more of the one or more fins are located outside of the computer chassis, wherein the natural convection flows against the one or more of the one or more fins to dissipate the heat.

7. The apparatus of claim 5, wherein the heat exchanger component employs one or more fans located outside of the computer chassis to dissipate the heat, wherein one or more of the one or more fins are operably located outside of the computer chassis, wherein the one or more fans force air against the one or more of the one or more fins to dissipate the heat.

8. The apparatus of claim 5, wherein the heat exchanger component employs one or more fans located inside of the computer chassis to dissipate the heat, wherein one or more of the one or more fins are operably located outside of the computer chassis, wherein the one or more fans force air against the one or more fins to dissipate the heat.

9. The apparatus of claim 2, wherein the heat exchanger component comprises one or more pump components, wherein the one or more pump components move the fluid through the one or more portions of tubing.

10. The apparatus of claim 2, wherein one or more cold plates abut one or more of the one or more heat producing components;

wherein one or more of the one or more portions of tubing pass through the one or more cold plates;

wherein the heat exchanger component passes the fluid through the one or more of the one or more portions of tubing to transfer heat from the one or more cold plates to the fluid;

wherein the cold plates transfer the heat from the one or more cold plates to the fluid to reduce the one or more of the one or more temperatures of the one or more heat producing components.

11. The apparatus of claim 2, wherein the fluid comprises a mixture of water and a coolant, wherein the heat exchanger component employs the mixture of water and the coolant to reduce the one or more of the one or more temperatures of the one or more heat producing components.

5 12. The apparatus of claim 1 in combination with the computer chassis, wherein the one or more heat exchanger components are coupled to an outer surface of the computer chassis.

13. The apparatus of claim 12, wherein the one or more heat exchanger components comprise a heat exchanger component, wherein the outer surface comprises a rear outer surface, wherein the heat exchanger component comprises a size that is less than or
10 equal to a size of the rear outer surface of the computer chassis;

wherein the computer chassis sits in a rack, wherein the size of the heat exchanger component allows removal of the computer chassis and the heat exchanger component from the rack.

15 14. The apparatus of claim 12, wherein the one or more heat exchanger components comprise a heat exchanger component, wherein the heat exchanger component is operably locatable at a location outside of the computer chassis;

wherein the location promotes an ease of accessibility to the heat exchanger component, wherein the ease of accessibility promotes an ease of serviceability of the heat
20 exchanger component.

15. The apparatus of claim 12, wherein the one or more heat exchanger components comprise a heat exchanger component, wherein the heat exchanger component is in major part operably locatable at a location outside of the computer chassis;

wherein a placement of the heat exchanger component at the location in major part
5 outside of the computer chassis rather than in major part inside the chassis, promotes an increase in available space inside the computer chassis, wherein the available space allows for a placement of one or more additional computer components within the computer chassis.

16. The apparatus of claim 1, wherein the one or more heat producing components comprise one or more processors located within the computer chassis, wherein the one or
10 more heat exchanger components serve to reduce one or more of the one or more temperatures of the one or more processors.

17. The apparatus of claim 1, wherein the one or more heat producing components comprise one or more circuit boards located within the computer chassis, wherein the one or more heat exchanger components serve to reduce one or more of the one or more
15 temperatures of the one or more circuit boards.

18. An apparatus, comprising:

means for passing a fluid against one or more heat producing components to promote a reduction of one or more temperatures of the one or more heat producing components; and

means for operably locating in major part outside of a computer chassis, the means for
5 passing the fluid against one or more heat producing components.

19. The apparatus of claim 18, wherein the means for passing the fluid against the one or more heat producing components to promote the reduction of the one or more temperatures of the one or more heat producing components comprise means for moving the fluid through one or more portions of tubing, wherein one or more of the one or more
10 portions of tubing abut the one or more heat producing components.

20. The apparatus of claim 19, wherein the means for moving the fluid through the one or more portions of tubing comprise means for moving the fluid between the one or more heat producing components and one or more fins located outside of the computer chassis, wherein one or more of the one or more portions of tubing abut the one or more fins.

15 21. The apparatus of claim 19, wherein the means for moving the fluid through the one or more portions of tubing comprise means for transferring heat from the one or more heat producing components to the fluid to reduce the one or more temperatures of the one or more heat producing components.

22. The apparatus of claim 21, wherein the means for transferring the heat from
20 the one or more heat producing components to the fluid to reduce the one or more temperatures of the one or more heat producing components comprise means for transferring the heat from the fluid to one or more fins located outside of the computer chassis.

23. The apparatus of claim 22, wherein the means for transferring the heat from the fluid to the one or more fins located outside of the computer chassis comprise means for forcing air against the one or more fins to promote a reduction of one or more temperatures of the one or more fins.

5 24. The apparatus of claim 18, wherein the computer chassis sits in a rack, wherein the means for operably locating in major part outside of the computer chassis, the means for passing the fluid against one or more heat producing components comprise means for increasing accessibility of the computer chassis in the rack to promote an ease of serviceability of the computer chassis.

25. A method, comprising the steps of:

employing one or more heat exchanger components to reduce one or more temperatures of one or more heat producing components; and

operably-locating the one or more heat exchanger components in major part outside of
5 a computer chassis.

26. The method of claim 25, wherein the one or more heat exchanger components comprise a heat exchanger component, wherein the heat exchanger component comprises one or more portions of tubing, wherein the step of employing the heat exchanger component to reduce the one or more temperatures of the one or more heat producing components
10 comprises the steps of:

pumping a mixture of water and a coolant through the one or more portions of tubing to the one or more heat producing components;

transferring heat from one or more of the one or more heat producing components with the mixture; and

15 pumping the mixture through the one or more portions of tubing from the one or more of the one or more heat producing components to the heat exchanger component.

27. The method of claim 26, further comprising the steps of:

transferring heat from the mixture to the one or more fins;

forcing air against one or more of the one or more fins; and

20 dissipating heat at the one or more of the one or more fins to reduce the one or more temperatures of the one or more of the one or more heat producing components.

28. The method of claim 26, wherein one or more of the one or more heat producing components abut one or more cold plates, wherein the step transferring heat from the one or more of the one or more heat producing components to the mixture comprises the steps of:

5 transferring heat from the one or more of the one or more heat producing components to the one or more cold plates;

 moving the mixture through the one or more cold plates in the one or more portions of tubing; and

 transferring the heat from the one or more cold plates to for a reduction of the one or
10 more temperatures of the one or more of the one or more heat producing components.

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